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November 2013

N-Channel QFET[®] MOSFET 600 V, 2.8 A, 2.5 Ω

Features

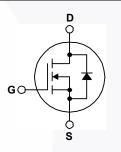
- 2.8 A, 600 V, $R_{DS(on)}$ = 2.5 Ω (Max.) @ V_{GS} = 10 V, I_D = 1.4 A
- Low Gate Charge (Typ. 15 nC)
- Low Crss (Typ. 6.5 pF)
- 100% Avalanche Tested
- RoHS compliant

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQD5N60CTM / FQU5N60CTU	Unit
V _{DSS}	Drain-Source Voltage		600	V
I _D	Drain Current - Continuous ($T_c = 25^{\circ}C$)		2.8	А
	- Continuous (T _C = 100°C)		1.8	А
I _{DM}	Drain Current - Pulsed	(Note 1)	11.2	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	210	mJ
I _{AR}	Avalanche Current (Note		2.8	А
E _{AR}	Repetitive Avalanche Energy (Not		4.9	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
	Power Dissipation (T _A = 25°C)*		2.5	W
PD	Power Dissipation ($T_C = 25^{\circ}C$)		49	W
	- Derate above 25°C		0.39	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C	

Thermal Characteristics

Symbol	Parameter	FQD5N60CTM / FQU5N60CTU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.56	
P	Thermal Resistance, Junction-to-Ambient (minimum pad of 2 oz copper), Max.	110	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (* 1 in ² pad of 2 oz copper), Max.	50	

Device	Marking	Device	Package	Reel Size	Таре	Width	Qua	antity
FQD!	FQD5N60C FQD5N60CTM		D-PAK 330 mm		16 mm		2500 units	
FQU5N60C FQU5N60CTU		I-PAK	I-PAK Tube		N/A		70 units	
Electri	cal Char	racteristics T _C = 25°	°C unless otherwise	noted.				
Symbol		Parameter	Test C	conditions	Min	Тур	Max	Unit
	aracteristi	cs						
BV _{DSS}	Drain-Sour	rce Breakdown Voltage	$V_{GS} = 0 V, I_D = 2$	250 μΑ	600			V
ΔBV_{DSS} / ΔT_{J}	Breakdowr Coefficient	n Voltage Temperature	I _D = 250 μA, Ref			0.6		V/°C
1	Zoro Coto	Valtage Drain Current	V_{DS} = 600 V, V_{GS}	-			1	μA
IDSS	Zero Gale	Voltage Drain Current	V _{DS} = 480 V, T _C				10	μA
I _{GSSF}	Gate-Body	/ Leakage Current, Forward	V_{GS} = 30 V, V_{DS}	= 0 V			100	nA
I _{GSSR}	Gate-Body	/ Leakage Current, Reverse	V_{GS} = -30 V, V_{DS}	₃ = 0 V			-100	nA
	aracteristi	cs						
V _{GS(th)}	Gate Three	shold Voltage	$V_{DS} = V_{GS}, I_D = 2$	250 μΑ	2.0		4.0	V
R _{DS(on)}	Static Drair On-Resista		V _{GS} = 10 V, I _D =			2.0	2.5	Ω
9 _{FS}	Forward Tr	ransconductance	V_{DS} = 40 V, I_{D} =	1.4 A		4.7		S
Dynam	ic Charac	teristics						
C _{iss}	Input Capa	citance	V _{DS} = 25 V, V _{GS}	= 0 V,		515	670	pF
C _{oss}	Output Cap		f = 1.0 MHz			55	72	pF
C _{rss}	Reverse Tr	ransfer Capacitance				6.5	8.5	pF
Switchi	ing Chara	cteristics						
t _{d(on)}	Turn-On De	elay Time	V _{DD} = 300 V, I _D =	= 4.5A.		10	30	ns
t _r	Turn-On Ri	ise Time	$R_{\rm G} = 25 \Omega$	1.0,		42	90	ns
t _{d(off)}	Turn-Off De	elay Time				38	85	ns
t _f	Turn-Off Fa			(Note 4)		46	100	ns
Qg	Total Gate		V _{DS} = 480 V, I _D =	= 4.5A,		15	19	nC
Q _{gs}	Gate-Source	-	V _{GS} = 10 V			2.5		nC
Q _{gd}	Gate-Drain	ı Charge		(Note 4)		6.6		nC
Droin S		ada Charactoristica (and Maximum E	Potingo				
		ode Characteristics a Continuous Drain-Source D		-	1	1	2.8	
le		COMMUNICAS DIAIN-SOURCE P	looe Folwalo Culle	(1)				A

ا _S	Maximum Continuous Drain-Source Diode Forward Current				2.8	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				11.2	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.8 A		-	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 4.5 A,		300		ns
Q _{rr}	Reverse Recovery Charge $dI_F / dt = 100 A/\mu s$		1	2.2		μC

NOTES:

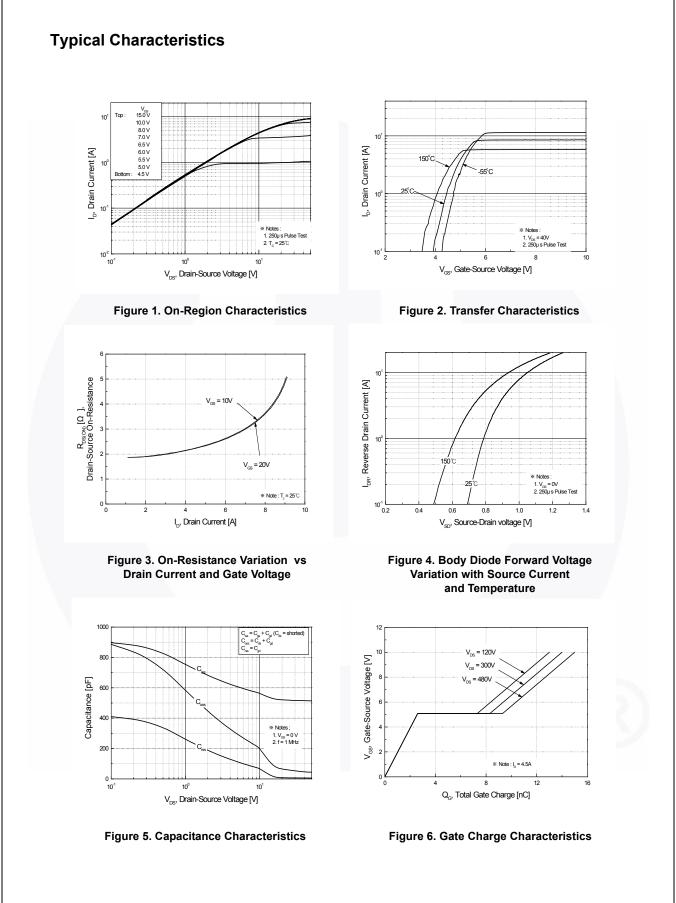
1. Repetitive Rating : Pulse width limited by maximum junction temperature.

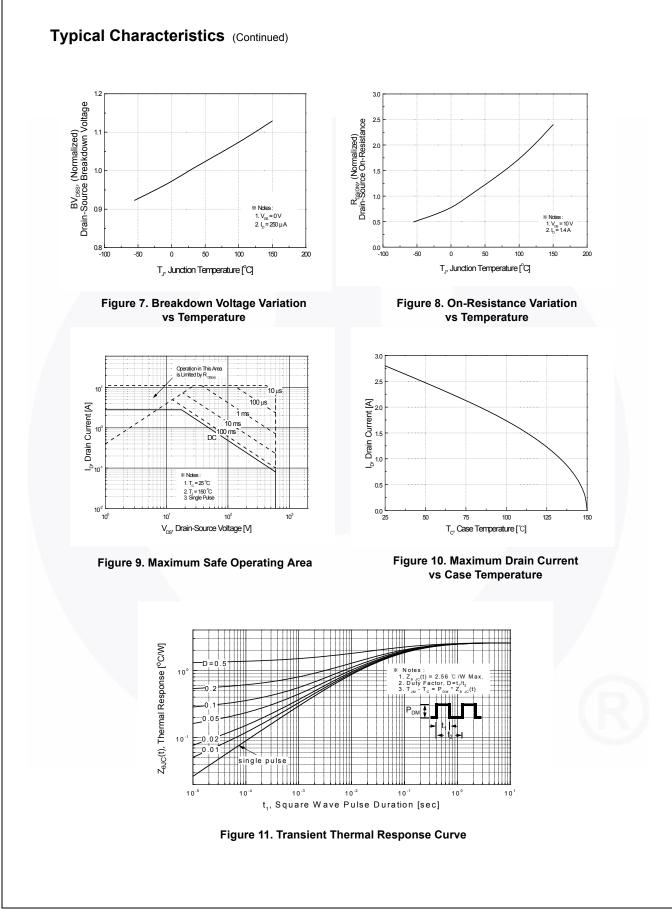
Package Marking and Ordering Information

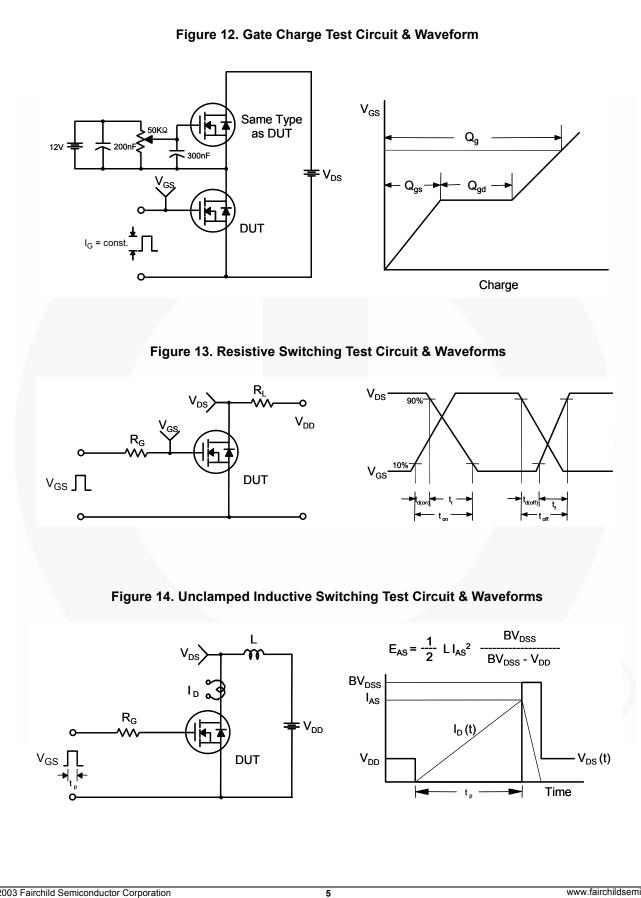
2. L = 18.9mH, I_{AS} = 4.5 A, V_{DD} = 50V, R_G = 25 $\Omega,$ starting $\mbox{ T}_{J}$ = 25°C.

3. I_{SD} \leq 4.5A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS,} starting ~T_J = 25°C.

4. Essentially independent of operating temperature.







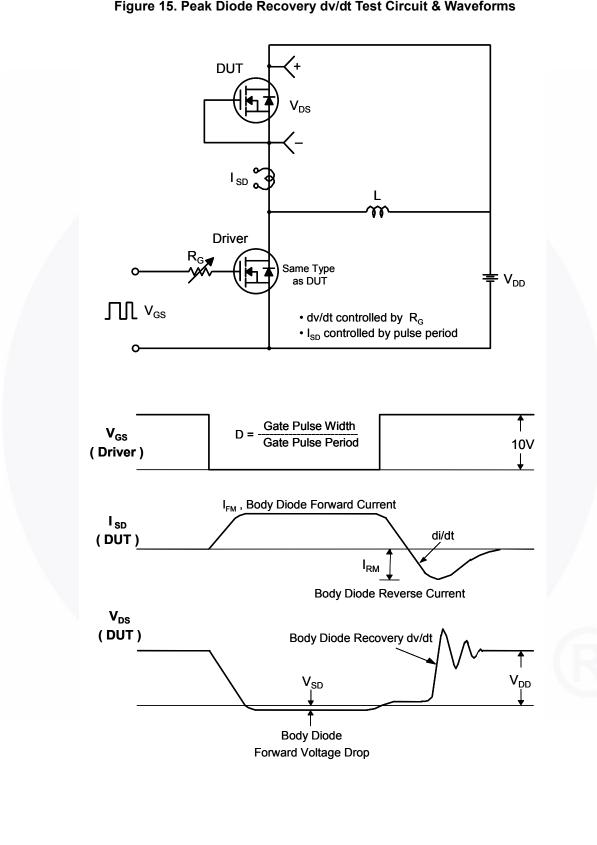
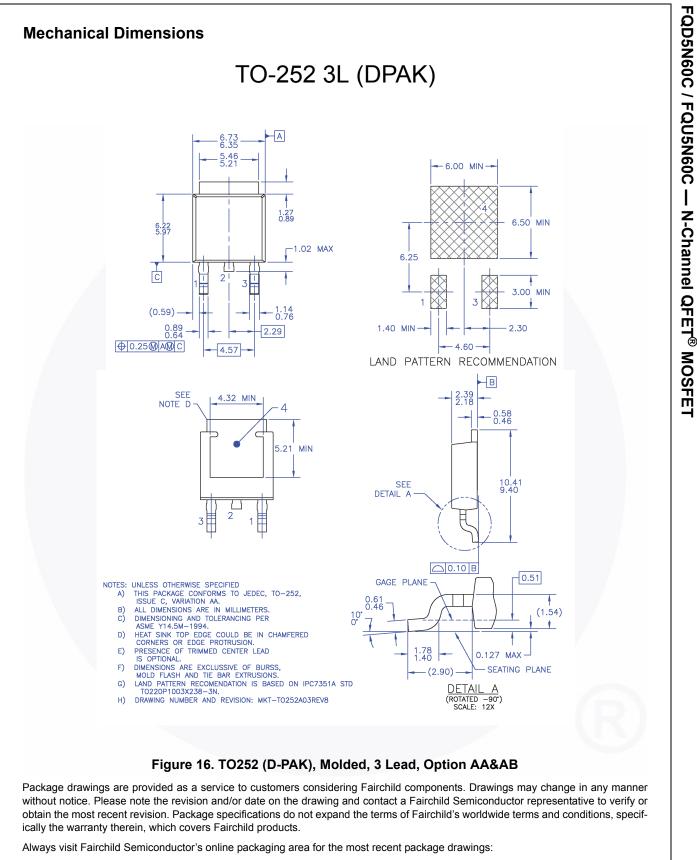
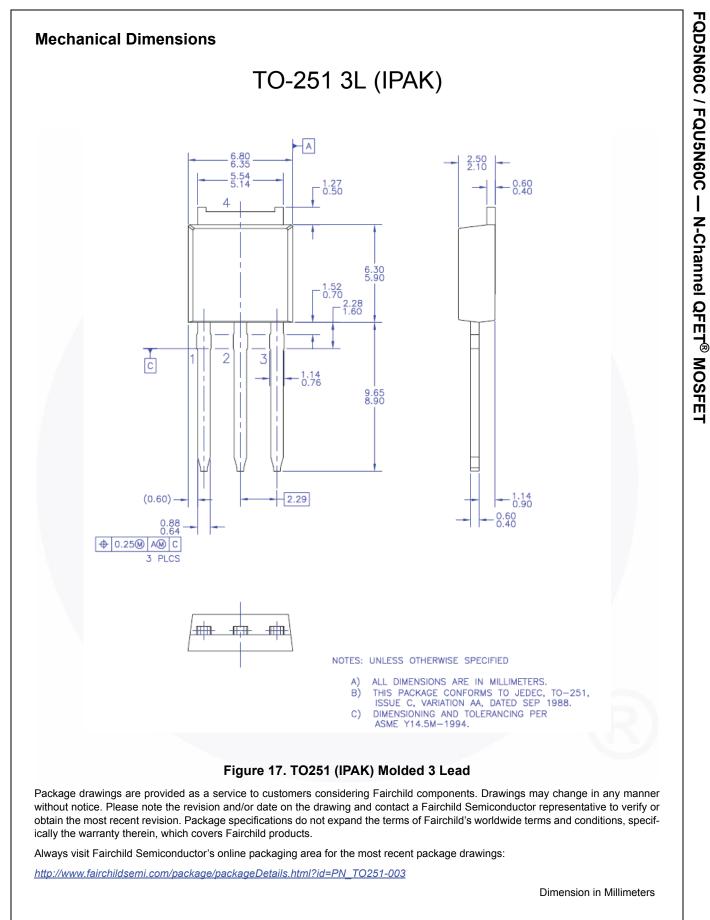


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT252-003

Dimension in Millimeters





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